

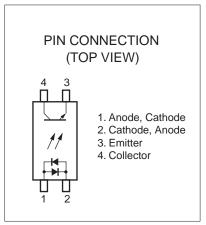
PS2915-1

The PS2915-1 is an optically coupled isolator containing GaAs light emitting diodes and an NPN silicon phototransistor in one package for high density mounting applications.

An ultra small flat-lead package has been provided which realizes a reduction in mounting area of about 30%, compared with the PS28xx series.

FEATURES

- Ultra small flat-lead package (4.6 (L) \times 2.5 (W) \times 2.1 (H) mm)
- High current transfer ratio (CTR = 200% TYP. @ IF = ± 1 mA, VCE = 5 V)
- High isolation voltage (BV = 2 500 Vr.m.s.)
- Ordering number of taping product: PS2915-1-F3, 3 500 pcs/reel
- <R> Safety standards
 - UL approved: UL1577, Single protection
 - BSI approved: BS EN 62368-1, Supplementary insulation
 - VDE approved: DIN EN 60747-5-5 (Option)



APPLICATIONS

- DC/DC converter
- Modem/PC card

The mark <R> shows major revised points.

The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

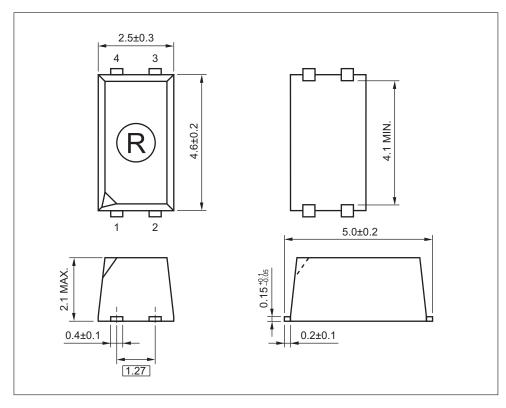


Rev.2.00

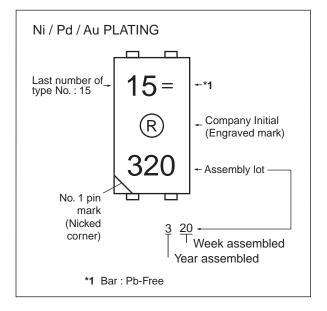
Jan 21, 2016

R08DS0112EJ0200

PACKAGE DIMENSIONS (UNIT: mm)



MARKING EXAMPLE



PHOTOCOUPLER CONSTRUCTION

Parameter	MIN.
Air Distance	4 mm
Creepage Distance	4 mm
Isolation Distance	0.4 mm



<R>

ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number ^{*1}
PS2915-1	PS2915-1-AX	Pb-Free	50 pcs (Tape 50 pcs cut)	Standard products	PS2915-1
PS2915-1-F3	PS2915-1-F3-AX	(Ni/Pd/Au)	Embossed Tape 3 500 pcs/reel	(UL, BSI approved)	
PS2915-1-V	PS2915-1-V-AX		50 pcs (Tape 50 pcs cut)	UL, BSI approved DIN EN 60747-5-5	
PS2915-1-V-F3	PS2915-1-V-F3-AX		Embossed Tape 3 500 pcs/reel	(VDE 0884-5) approved (Option)	

Note: *1. For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise specified)

	Parameter	Symbol	Ratings	Unit
Diode	Forward Current	lF	±50	mA
	Forward Current Derating	⊿lF/°C	0.5	mA/°C
	Peak Forward Current*1		±0.5	А
	Power Dissipation	PD	60	mW
Transistor Collector to Emitter Voltage		VCEO	40	V
	Emitter to Collector Voltage	Veco	5	V
	Collector Current	Ic	40	mA
	Power Dissipation Derating	⊿Pc/°C	1.2	mW/°C
	Power Dissipation	Pc	120	mW
Isolation Voltage*2		BV	2 500	Vr.m.s.
Total Power Dissipation		Рт	160	mW
Operating Ambient Temperature		Та	–55 to +100	°C
Storage Temperature		Tstg	–55 to +150	°C

Notes: *1. PW = 100 μ s, Duty Cycle = 1%

*2. AC voltage for 1 minute at $T_A = 25^{\circ}$ C, RH = 60% between input and output Pins 1-2 shorted together, 3-4 shorted together.



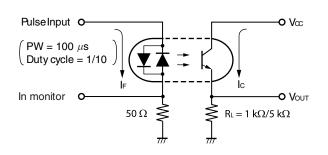
Symbol Conditions MIN. TYP. Parameter MAX. Unit Diode Vf 0.9 V Forward Voltage $IF = \pm 1 mA$ 1.1 1.3 **Terminal Capacitance** Ct V = 0 V, f = 1 MHz 30 pF Transistor Collector to Emitter Dark IF = 0 mA, VCE = 40 VICEO 100 nA Current Coupled Current Transfer Ratio (IC/IF)*1 IF = ± 1 mA, VCE = 5 V CTR 100 200 400 % Collector Saturation Voltage $IF = \pm 1 \text{ mA}, IC = 0.2 \text{ mA}$ 0.13 0.3 V VCE (sat) 10¹¹ Isolation Resistance RI-0 $VI-O = 1 \ kVDC$ Ω **Isolation Capacitance** CI-0 V = 0 V, f = 1 MHz 0.4 pF Rise Time*2 Vcc = 5 V, Ic = 2 mA, $RL = 1 k\Omega$ tr 5 μS Fall Time*2 tf 10 Turn-on Time^{*2} VCC = 5 V, IF = ± 1 mA, 40 ton μS $RL = 5 k\Omega$ Storage Time*2 ts 10 μS Turn-off Time*2 toff 120 μs

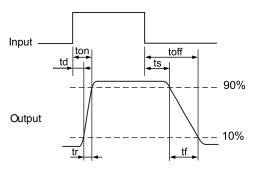
ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$)

Notes: *1 CTR rank

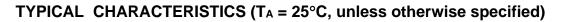
N : 100 to 400 (%)

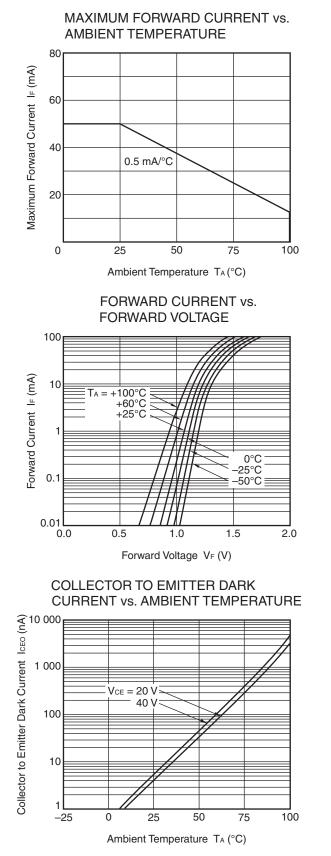
*2 Test circuit for switching time



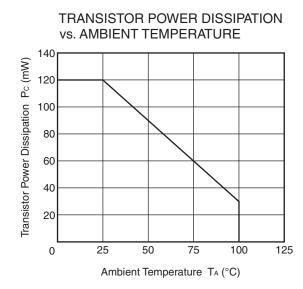




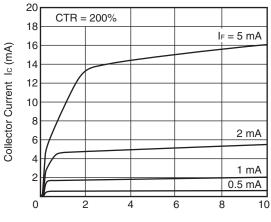






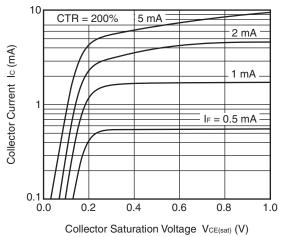


COLLECTOR CURRENT vs. COLLECTOR TO EMITTER VOLTAGE

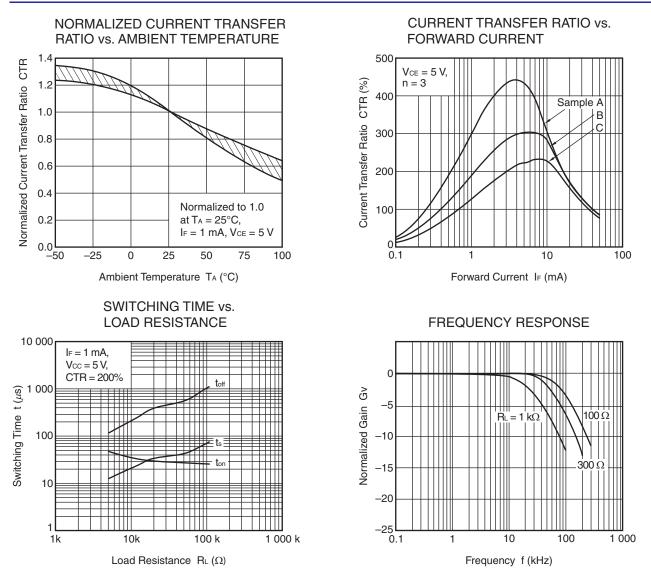


Collector to Emitter Voltage VCE (V)

COLLECTOR CURRENT vs. COLLECTOR SATURATION VOLTAGE



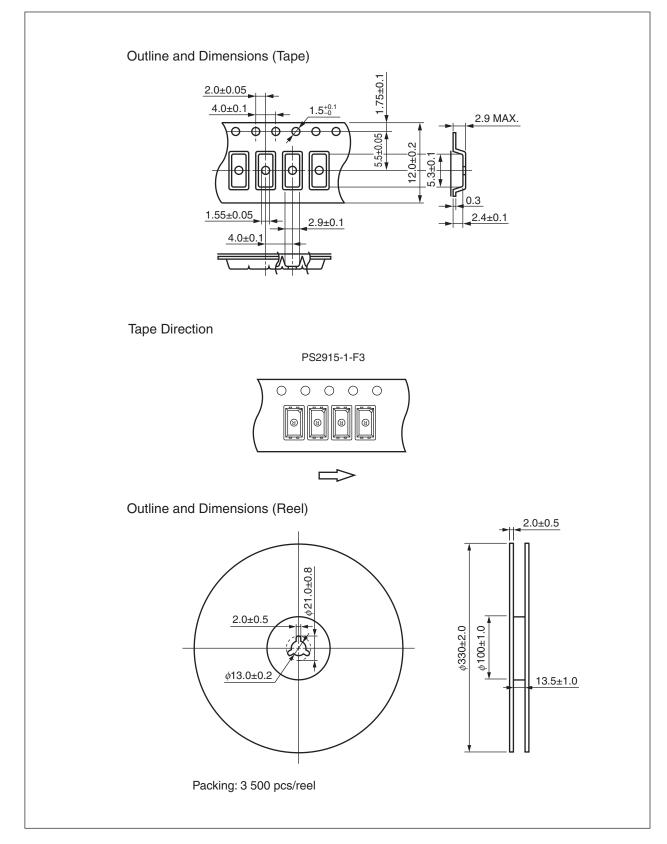




Remark The graphs indicate nominal characteristics.

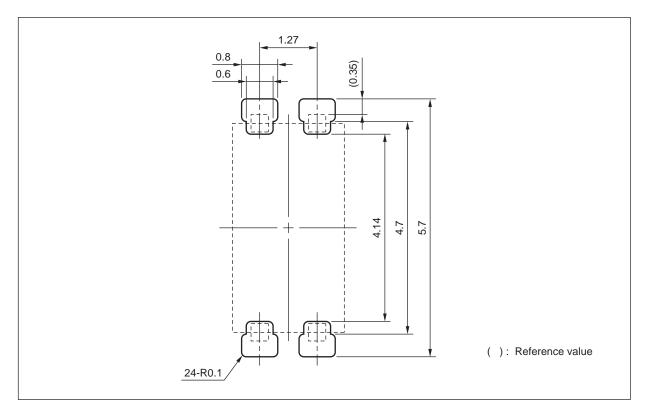


<R> TAPING SPECIFICATIONS (UNIT: mm)





RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



Remark This drawing is considered to meet air and outer creepage distance 4.0 mm minimum. All dimensions in this figure must be evaluated before use.



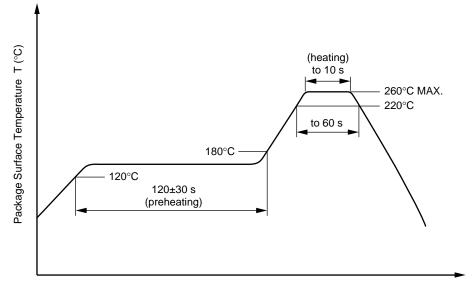
NOTES ON HANDLING

- 1. Recommended soldering conditions
 - (1) Infrared reflow soldering
 - Peak reflow temperature
 - Time of peak reflow temperature
 - Time of temperature higher than 220°C
 - Time to preheat temperature from 120 to $180^{\circ}C$
 - Number of reflows
 - Flux

260°C or below (package surface temperature) 10 seconds or less 60 seconds or less 120 ± 30 s Three Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is

recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)
 - Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

- Peak Temperature (lead part temperature) 350°C or below
- Time (each pins) 3 seconds or less
- Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.

(4) Cautions

• Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.



2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

3. Measurement conditions of current transfer ratios (CTR), which differ according to photocoupler

Check the setting values before use, since the forward current conditions at CTR measurement differ according to product.

When using products other than at the specified forward current, the characteristics curves may differ from the standard curves due to CTR value variations or the like. Therefore, check the characteristics under the actual operating conditions and thoroughly take variations or the like into consideration before use.

USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.



SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

Parameter	Symbol	Spec.	Unit
Climatic test class (IEC 60068-1/DIN EN 60068-1)		55/100/21	
Dielectric strength			
maximum operating isolation voltage	UIORM	570	V_{peak}
Test voltage (partial discharge test, procedure a for type test and random test)	Upr	912	V_{peak}
$U_{pr} = 1.6 \times U_{IORM.}, P_d < 5 \ pC$			
Test voltage (partial discharge test, procedure b for all devices)	Upr	1068	V _{peak}
$U_{pr} = 1.875 \times U_{IORM.}, \ P_d < 5 \ pC$			
Highest permissible overvoltage	U _{TR}	4 000	V _{peak}
Degree of pollution (DIN EN 60664-1 VDE0110 Part 1)		2	
Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303 Part 11))	CTI	175	
Material group (DIN EN 60664-1 VDE0110 Part 1)		III a	
Storage temperature range	T _{stg}	-55 to +150	°C
Operating temperature range	TA	-55 to +100	°C
Isolation resistance, minimum value			
$V_{IO} = 500 \text{ V dc at } T_A = 25^{\circ}\text{C}$	Ris MIN.	10 ¹²	Ω
$V_{IO} = 500 \text{ V} \text{ dc} \text{ at } T_A \text{ MAX. at least } 100^{\circ}\text{C}$	Ris MIN.	10 ¹¹	Ω
Safety maximum ratings (maximum permissible in case of fault, see thermal			
derating curve)			
Package temperature	Tsi	150	°C
Current (input current I _F , Psi = 0)	lsi	300	mA
Power (output or total power dissipation)	Psi	500	mW
Isolation resistance			
$V_{IO} = 500 \text{ V dc at } T_A = Tsi$	Ris MIN.	10 ⁹	Ω



Caution GaAs Products	This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.
	• Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
	 Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
	2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
	• Do not burn, destroy, cut, crush, or chemically dissolve the product.
	• Do not lick the product or in any way allow it to enter the mouth.



Revision History

PS2915-1 Data Sheet

		Description		
Rev.	Date	Page	Summary	
2.00	May 25, 2006	_	First edition issued	
1.00	Nov 01, 2013	Throughout Renesas format is applied to this data sheet.		
		p.1	Modification of FEATURES	
		p.2	Modification of PACKAGE DIMENSIONS	
			Modification of MARKING EXAMPLE	
		p.3	Modification of ORDERING INFORMATION	
		p.4	Modification of ELECTRICAL CHARACTERISTICS	
		p.6	Modification of TYPICAL CHARACTERISTICS	
		p.7	Modification of TAPING SPECIFICATIONS	
		p.9	Modification of NOTES ON HANDLING	
		p.11	Addition of SPECIFICATION OF VDE MARKS LICENSE DOCUMENT	
2.00	Jan 21, 2016	p.1	Update of FEATURES - Safety standards	
		p.3	Modification of ORDERING INFORMATION	
		p.7	Modification of TAPING SPECIFICATIONS	

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